

SN74LVC4245A-EP OCTAL BUS TRANSCEIVER AND 3.3-V TO 5-V SHIFTER WITH 3-STATE OUTPUTS

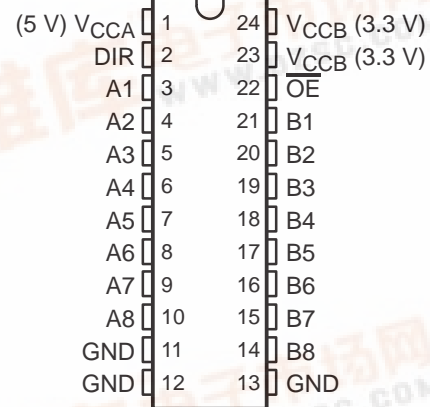
SCAS742 – DECEMBER 2003

查询"SN74LVC4245A-EP"供应商

- **Controlled Baseline**
 - One Assembly/Test Site, One Fabrication Site
- **Enhanced Diminishing Manufacturing Sources (DMS) Support**
- **Enhanced Product-Change Notification**
- **Qualification Pedigree†**
- **Bidirectional Voltage Translator**
- **5.5 V on A Port and 2.7 V to 3.6 V on B Port**
- **Latch-Up Performance Exceeds 250 mA Per JESD 17**
- **ESD Protection Exceeds JESD 22**
 - 2000-V Human-Body Model (A114-A)
 - 200-V Machine Model (A115-A)
 - 1000-V Charged-Device Model (C101)

† Component qualification in accordance with JEDEC and industry standards to ensure reliable operation over an extended temperature range. This includes, but is not limited to, Highly Accelerated Stress Test (HAST) or biased 85/85, temperature cycle, autoclave or unbiased HAST, electromigration, bond intermetallic life, and mold compound life. Such qualification testing should not be viewed as justifying use of this component beyond specified performance and environmental limits.

PW PACKAGE
(TOP VIEW)



description/ordering information

This 8-bit (octal) noninverting bus transceiver contains two separate supply rails; B port has V_{CCB} , which is set at 3.3 V, and A port has V_{CCA} , which is set at 5 V. This allows for translation from a 3.3-V to a 5-V environment, and vice versa.

The SN74LVC4245A is designed for asynchronous communication between data buses. The device transmits data from the A bus to the B bus or from the B bus to the A bus, depending on the logic level at the direction-control (DIR) input. The output-enable (\overline{OE}) input can be used to disable the device so the buses are effectively isolated.

The SN74LVC4245A pinout allows the designer to switch to a normal all-3.3-V or all-5-V 20-pin '245 device without board re-layout. The designer uses the data paths for pins 2–11 and 14–23 of the SN74LVC4245A to align with the conventional '245 pinout.

ORDERING INFORMATION

T_A	PACKAGE‡		ORDERABLE PART NUMBER	TOP-SIDE MARKING
–40°C to 85°C	TSSOP – PW	Reel of 2000	SN74LVC4245AIPWREP	C4245AEP

‡ Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

FUNCTION TABLE

INPUTS		OPERATION
\overline{OE}	DIR	
L	L	B data to A bus
L	H	A data to B bus
H	X	Isolation



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PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

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recommended operating conditions for $V_{CCA} = 4.5\text{ V to }5.5\text{ V}$ (see Note 4)

	MIN	MAX	UNIT
V_{CCA} Supply voltage	4.5	5.5	V
V_{IH} High-level input voltage	2		V
V_{IL} Low-level input voltage		0.8	V
V_I Input voltage	0	V_{CCA}	V
V_O Output voltage	0	V_{CCA}	V
I_{OH} High-level output current		-24	mA
I_{OL} Low-level output current		24	mA
T_A Operating free-air temperature	-40	85	°C

NOTE 4: All unused inputs of the device must be held at the associated V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

recommended operating conditions for $V_{CCB} = 2.7\text{ V to }3.6\text{ V}$ (see Note 4)

			MIN	MAX	UNIT
V _{CCB}	Supply voltage		2.7	3.6	V
V _{IH}	High-level input voltage	V _{CCB} = 2.7 V to 3.6 V	2		V
V _{IL}	Low-level input voltage	V _{CCB} = 2.7 V to 3.6 V		0.8	V
V _I	Input voltage		0	V _{CCB}	V
V _O	Output voltage		0	V _{CCB}	V
I _{OH}	High-level output current	V _{CCB} = 2.7 V		−12	mA
		V _{CCB} = 3 V		−24	
I _{OL}	Low-level output current	V _{CCB} = 2.7 V		12	mA
		V _{CCB} = 3 V		24	
T _A	Operating free-air temperature		−40	85	°C

NOTE 4: All unused inputs of the device must be held at the associated V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.



SN74LVC4245A-EP

OCTAL BUS TRANSCEIVER AND 3.3-V TO 5-V SHIFTER

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SCAS331P SN74LVC4245A-EP 供应商

electrical characteristics over recommended operating free-air temperature range for $V_{CCA} = 4.5\text{ V to }5.5\text{ V}$ (unless otherwise noted) (see Note 5)

PARAMETER		TEST CONDITIONS	V_{CCA}	MIN	TYP†	MAX	UNIT
V_{OH}		$I_{OH} = -100\text{ }\mu\text{A}$	4.5 V	4.3			V
			5.5 V	5.3			
		$I_{OH} = -24\text{ mA}$	4.5 V	3.7			
			5.5 V	4.7			
V_{OL}		$I_{OL} = 100\text{ }\mu\text{A}$	4.5 V			0.2	V
			5.5 V			0.2	
		$I_{OL} = 24\text{ mA}$	4.5 V			0.55	
			5.5 V			0.55	
I_I	Control inputs	$V_I = V_{CCA}$ or GND	5.5 V			± 1	μA
I_{OZ}^\ddagger	A port	$V_O = V_{CCA}$ or GND	5.5 V			± 5	μA
I_{CCA}		$V_I = V_{CCA}$ or GND, $I_O = 0$	5.5 V			80	μA
ΔI_{CCA}^\S		One input at 3.4 V, Other inputs at V_{CCA} or GND	5.5 V			1.5	mA
C_i	Control inputs	$V_I = V_{CCA}$ or GND	Open		5		pF
C_{io}	A port	$V_O = V_{CCA}$ or GND	5 V		11		pF

† All typical values are measured at $V_{CC} = 5\text{ V}$, $T_A = 25^\circ\text{C}$.

‡ For I/O ports, the parameter I_{OZ} includes the input leakage current.

§ This is the increase in supply current for each input that is at one of the specified TTL voltage levels, rather than 0 V or the associated V_{CC} .

NOTE 5: $V_{CCB} = 2.7\text{ V to }3.6\text{ V}$

electrical characteristics over recommended operating free-air temperature range for $V_{CCB} = 2.7\text{ V to }3.6\text{ V}$ (unless otherwise noted) (see Note 6)

PARAMETER		TEST CONDITIONS	V_{CCB}	MIN	TYP†	MAX	UNIT
V_{OH}		$I_{OH} = -100\text{ }\mu\text{A}$	2.7 V to 3.6 V	$V_{CC}-0.2$			V
			2.7 V	2.2			
		$I_{OH} = -12\text{ mA}$	3 V	2.4			
			3 V	2			
V_{OL}		$I_{OL} = 100\text{ }\mu\text{A}$	2.7 V to 3.6 V			0.2	V
		$I_{OL} = 12\text{ mA}$	2.7 V			0.4	
		$I_{OL} = 24\text{ mA}$	3 V			0.55	
I_{OZ}^\ddagger	B port	$V_O = V_{CCB}$ or GND	3.6 V			± 5	μA
I_{CCB}		$V_I = V_{CCB}$ or GND, $I_O = 0$	3.6 V			50	μA
ΔI_{CCB}^\S		One input at $V_{CCB} - 0.6\text{ V}$, Other inputs at V_{CCB} or GND	2.7 V to 3.6 V			0.5	mA
C_{io}	B port	$V_O = V_{CCB}$ or GND	3.3 V		11		pF

‡ For I/O ports, the parameter I_{OZ} includes the input leakage current.

§ This is the increase in supply current for each input that is at one of the specified TTL voltage levels, rather than 0 V or the associated V_{CC} .

† All typical values are measured at $V_{CC} = 3.3\text{ V}$, $T_A = 25^\circ\text{C}$.

NOTE 6: $V_{CCA} = 5\text{ V} \pm 0.5\text{ V}$



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switching characteristics over recommended operating free-air temperature range, $C_L = 50$ pF (unless otherwise noted) (see Figures 1 and 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	$V_{CCA} = 5\text{ V} \pm 0.5\text{ V}$, $V_{CCB} = 2.7\text{ V TO } 3.6\text{ V}$		UNIT
			MIN	MAX	
t_{PHL}	A	B	1	6.3	ns
t_{PLH}			1	6.7	
t_{PHL}	B	A	1	6.1	ns
t_{PLH}			1	5	
t_{PZL}	\overline{OE}	A	1	9	ns
t_{PZH}			1	8.1	
t_{PZL}	\overline{OE}	B	1	8.8	ns
t_{PZH}			1	9.8	
t_{PLZ}	\overline{OE}	A	1	7	ns
t_{PHZ}			1	5.8	
t_{PLZ}	\overline{OE}	B	1	7.7	ns
t_{PHZ}			1	7.8	

operating characteristics, $V_{CCA} = 4.5\text{ V to } 5.5\text{ V}$, $V_{CCB} = 2.7\text{ V to } 3.6\text{ V}$, $T_A = 25^\circ\text{C}$

PARAMETER		TEST CONDITIONS		TYP	UNIT
C_{pd}	Power dissipation capacitance per transceiver	Outputs enabled	$C_L = 0$, $f = 10\text{ MHz}$	39.5	pF
		Outputs disabled		5	

power-up considerations†

TI level-translation devices offer an opportunity for successful mixed-voltage signal design. A proper power-up sequence always should be followed to avoid excessive supply current, bus contention, oscillations, or other anomalies caused by improperly biased device pins. Take these precautions to guard against such power-up problems.

1. Connect ground before any supply voltage is applied.
2. Power up the control side of the device (V_{CCA} for all four of these devices).
3. Tie \overline{OE} to V_{CCA} with a pullup resistor so that it ramps with V_{CCA} .
4. Depending on the direction of the data path, DIR can be high or low. If DIR high is needed (A data to B bus), ramp it with V_{CCA} . Otherwise, keep DIR low.

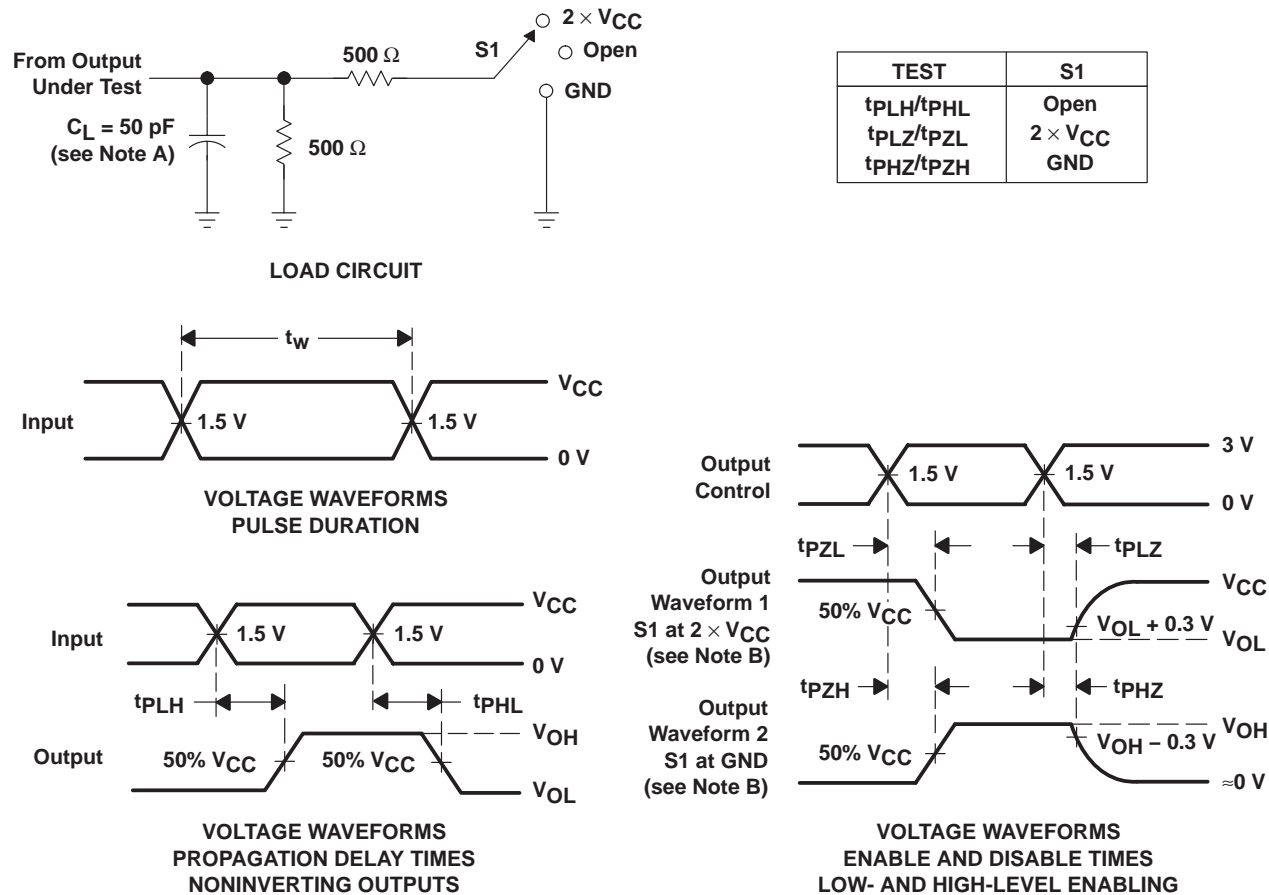
† Refer to the TI application report, *Texas Instruments Voltage-Level-Translation Devices*, literature number SCEA021.



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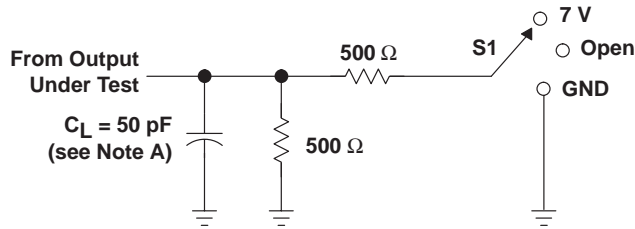
PARAMETER MEASUREMENT INFORMATION A PORT



- NOTES:
- A. C_L includes probe and jig capacitance.
 - B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 - C. All input pulses are supplied by generators having the following characteristics: $PRR \leq 10 \text{ MHz}$, $Z_O = 50 \Omega$, $t_r \leq 2.5 \text{ ns}$, $t_f \leq 2.5 \text{ ns}$.
 - D. The outputs are measured one at a time with one transition per measurement.
 - E. All parameters and waveforms are not applicable to all devices.

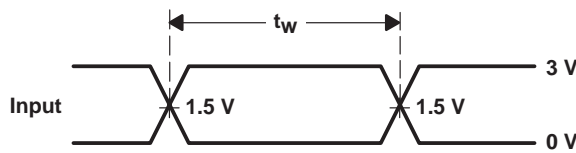
Figure 1. Load Circuit and Voltage Waveforms

PARAMETER MEASUREMENT INFORMATION B PORT

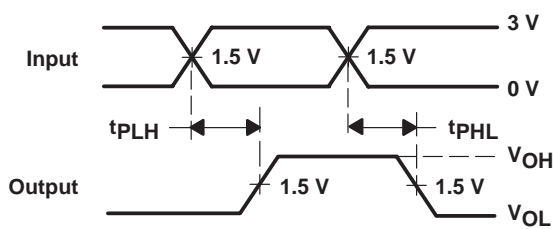


LOAD CIRCUIT

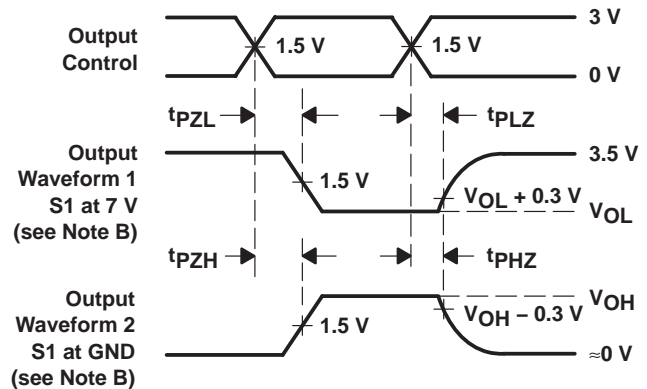
TEST	S1
t_{PLH}/t_{PHL}	Open
t_{PLZ}/t_{PZL}	7 V
t_{PHZ}/t_{PZH}	GND



VOLTAGE WAVEFORMS
PULSE DURATION



VOLTAGE WAVEFORMS
PROPAGATION DELAY TIMES
NONINVERTING OUTPUTS



VOLTAGE WAVEFORMS
ENABLE AND DISABLE TIMES
LOW- AND HIGH-LEVEL ENABLING

- NOTES: A. C_L includes probe and jig capacitance.
 B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 C. All input pulses are supplied by generators having the following characteristics: $PRR \leq 10 \text{ MHz}$, $Z_O = 50 \Omega$, $t_r \leq 2.5 \text{ ns}$, $t_f \leq 2.5 \text{ ns}$.
 D. The outputs are measured one at a time with one transition per measurement.
 E. All parameters and waveforms are not applicable to all devices.

Figure 2. Load Circuit and Voltage Waveforms

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
SN74LVC4245AIPWREP	ACTIVE	TSSOP	PW	24	2000	TBD	Call TI	Level-1-250C-UNLIM
V62/04664-01XE	ACTIVE	TSSOP	PW	24	2000	TBD	Call TI	Level-1-250C-UNLIM

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBsolete: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

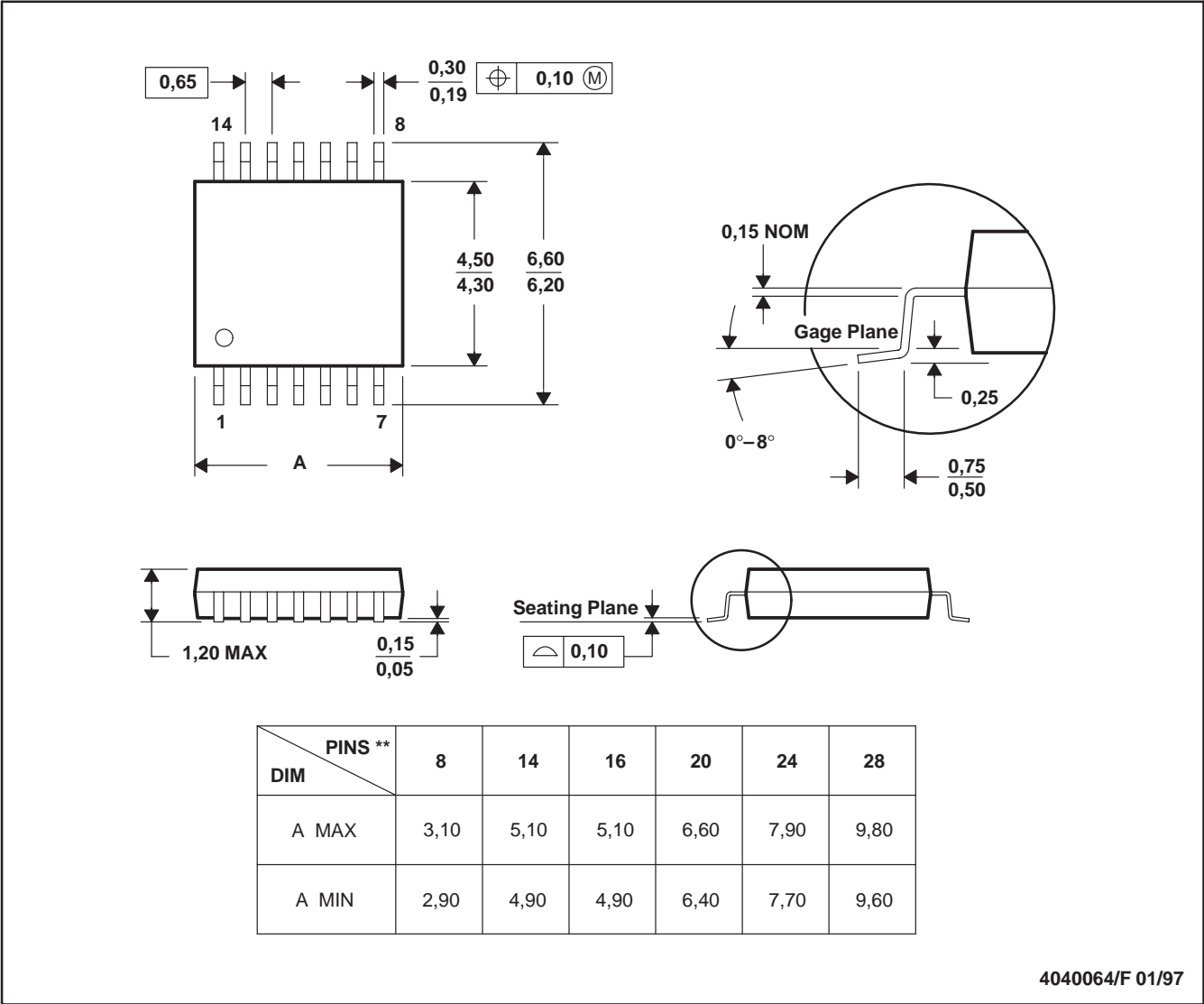
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PW (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

14 PINS SHOWN



- NOTES: A. All linear dimensions are in millimeters.
B. This drawing is subject to change without notice.
C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
D. Falls within JEDEC MO-153

PACKAGING INFORMATION

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SN74LVC4245AIPWREP	ACTIVE	TSSOP	PW	24	2000	TBD	CU NIPDAU	Level-1-250C-UNLIM
V62/04664-01XE	ACTIVE	TSSOP	PW	24	2000	TBD	CU NIPDAU	Level-1-250C-UNLIM

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Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

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Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

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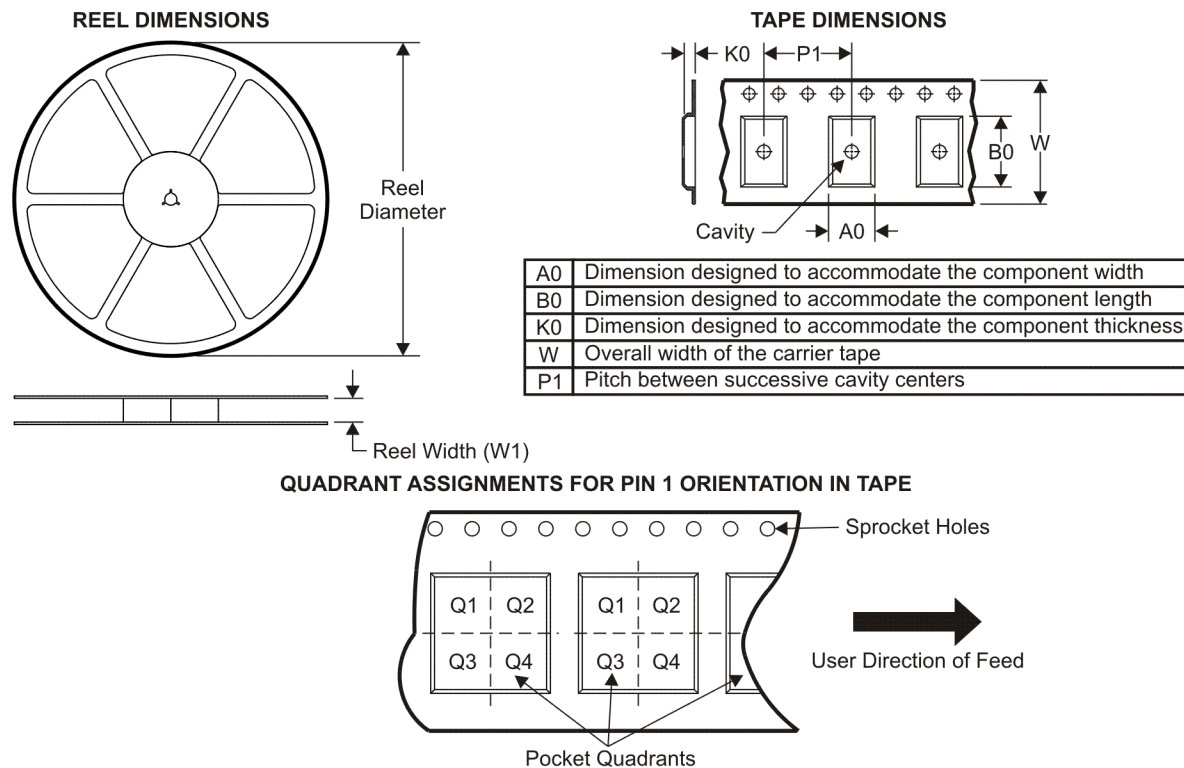
OTHER QUALIFIED VERSIONS OF SN74LVC4245A-EP :

- Catalog: [SN74LVC4245A](#)

NOTE: Qualified Version Definitions:

- Catalog - TI's standard catalog product

TAPE AND REEL INFORMATION



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74LVC4245AIPWREP	TSSOP	PW	24	2000	330.0	16.4	6.95	8.3	1.6	8.0	16.0	Q1

TAPE AND REEL BOX DIMENSIONS



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74LVC4245AIPWREP	TSSOP	PW	24	2000	346.0	346.0	33.0

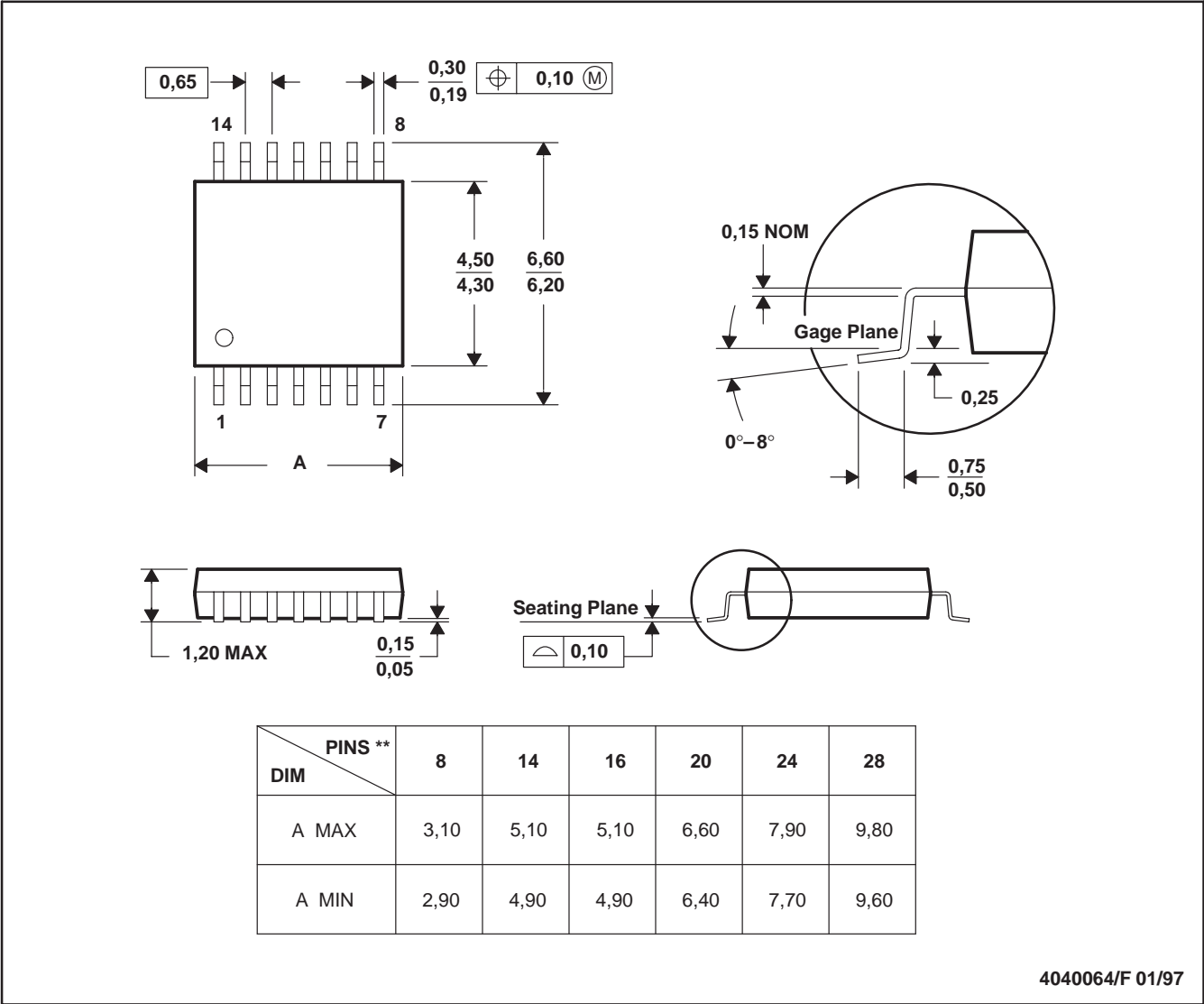
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MTSS001C – JANUARY 1995 – REVISED FEBRUARY 1999

PW (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

14 PINS SHOWN



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D. Falls within JEDEC MO-153

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